EAST Search History

| Ref # | Hits | Search Query | DBs | Default Operat or | Plural s | Time Stamp |
|----------|--------|---|--|-------------------------|-------------|---------------------|
| L1 | 10 | ("5276304" or "6835643" or "6096649" or "6457234" or "4518112").pn. | US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB | OR | ON | 2006/07/17 14:45 |
| L2 | 3 | 1 and ((gold or Au)adj wire) | US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; | OR | ON | 2006/07/17 14:48 |
| L3 | 6 | 1 and (gold or Au) | IBM_TDB US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB | OR | ON | 2006/07/17 15:12 |
| L9 | 348099 | "257"/\$.ccls. | US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB | OR | ON | 2006/07/17 16:17 |
| L10 | 2710 | 438/612.ccls. | US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB | OR | ON | 2006/07/17 16:17 |

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| · L11 | 1533 | 438/613.ccls. | US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB | OR | ON | 2006/07/17 16:18 |
|-------|------|--|--|----|----|---------------------|
| L12 | 2162 | 438/614.ccls. | US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB | OR | ON | 2006/07/17 16:18 |
| L13 | 5448 | 10 or 11 or 12 | US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB | OR | ON | 2006/07/17 16:18 |
| L14 | 13 | 13 and copper same (damascene or interconnect) same (gold or Au) same wire same (combin\$5 or alloy) same (tin or Sn or In or indium) | US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB | OR | ON | 2006/07/17 16:27 |
| L15 | 32 | copper same (damascene or interconnect) same (gold or Au) adj wire same (combin\$5 or alloy) same (tin or Sn or In or indium) | US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB | OR | ON | 2006/07/17 16:27 |

7/17/2006 5:06:56 PM
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|-------|----|---|--|----|----|---------------------|
| \ L16 | 8 | copper near5(damascene or interconnect) same (gold or Au) adj wire same (combin\$5 or alloy) same (tin or Sn or In or indium) | US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB | OR | ON | 2006/07/17 16:36 |
| L17 | 13 | interconnect with (gold or Au) adj wire same (combin\$5 or alloy) same (tin or Sn or In or indium) | US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB | OR | ON | 2006/07/17 16:39 |
| L18 | 62 | (gold or Au) adj wire near5 (combin\$5 or alloy) near5 (tin or Sn or In or indium) | US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB | OR | ON | 2006/07/17 16:39 |

7/17/2006 5:06:56 PM
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